



Type SF333-xx32 High Frequency Inverter grade Capsule Thyristor

Distributed amplified gate for high di/dt and low switching losses

Maximum mean on-state current						I_{FAV}	320 A		
Maximum repetitive peak off-state and reverse voltage						U_{DRM}	1200 ÷ 2200 V		
Turn-off time						U_{RRM}			
						tq	20; 25; 32 μs		
U_{DRM}, U_{RRM}, V		1200	1300	1400	1500	1600	1800	2000	2200
Voltage code - XX		12	13	14	15	16	18	20	22
$T_{vj}, °C$	- 60 ÷ 125								

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	SF333-xx32	Conditions
I_{FAV}	Mean on-state current	A	320 537	$T_c=91°C,$ $T_c=55°C,$ 180° half-sine wave, 50 Hz
I_{TRMS}	RMS on-state current	A	502	$T_c=91 °C, 50 Hz$
I_{TSM}	Surge on-state current	kA	6,3	$T_{vj}=125°C U_R=0 t_p=10 ms$
(di/dt) cr	Critical rate of rise of on-state current: non – repetitive repetitive	A/μs	1600 800	$T_{vj}=125°C; U_D=0,67 U_{DRM},$ Gate pulse : 10V,5Ω, 1μs rise time, 10μs
U_{RGM}	Peak reverse gate voltage	V	5	
T_{stg}	Storage temperature	°C	-60 ÷ 125	
T_{vj}	Junction temperature	°C	-60 ÷ 125	

CHARACTERISTICS

Symbols and parameters		Units	SF333xx32	Conditions
U_{TM}	Peak on-state voltage	V	2,7	$T_{vj}=25°C, I_{TM}=3,14 I_{TAV}$
$U_{T(To)}$	Threshold voltage	V	1,6	$T_{vj}=125°C$
r_T	Slope resistance	mΩ	1,25	$T_{vj}=125°C$
I_{DRM} I_{RRM}	Repetitive peak off-state and reverse current	mA	70 70	$T_{vj}=125°C,$ $U_D= U_{DRM}$ $U_R= U_{RRM}$

I_L	Latching current	A	5	$T_{vj}=25^{\circ}\text{C}$; $U_D=12\text{V}$, Gate pulse: 10V, 5 Ω , 1 μs rise time, 10 μs
I_H	Holding current	A	1,0	$T_{vj}=25^{\circ}\text{C}$; $U_D=12$, Gate open
U_{GT}	Gate trigger direct voltage	V	2,5	$T_{vj}=25^{\circ}\text{C}$; $U_D=12\text{V}$
I_{GT}	Gate trigger direct current	A	0,3	$T_{vj}=25^{\circ}\text{C}$; $U_D=12\text{V}$
U_{GD}	Gate non-trigger direct voltage	V	0,25	$T_{vj}=125^{\circ}\text{C}$; $U_D=0,67 U_{DRM}$
tgd	Delay time	μs	1,6	$T_{vj}=25^{\circ}\text{C}$, $U_D=500\text{V}$, $I_{TM}=320\text{A}$
tgt	Turn-on time	μs	2,5	Gate pulse: 10V, 5 Ω , 1 μs rise time, 10 μs
tq	Turn-off time	μs	20÷32 25÷40	$T_{vj}=125^{\circ}\text{C}$, $I_{TM}=320\text{A}$, $di_R/dt= 10 \text{ A}/\mu\text{s}$ $U_R=100\text{V}$ $U_D=0,67 U_{DRM}$ $Di_D/dt= 50 \text{ A}/\mu\text{s}$ $Di_D/dt= 200 \text{ A}/\mu\text{s}$
Qrr	Recovered charge	μC	300	$T_{vj}=125^{\circ}\text{C}$, $I_{TM}=320\text{A}$, $di_R/dt= 50 \text{ A}/\mu\text{s}$, $U_R=100\text{V}$
(di_D/dt) cr	Critical rate of rise of off-state voltage	V/ μs	500 1000	$T_{vj}=125^{\circ}\text{C}$; $U_D=0,67 U_{DRM}$ Gate open
Rthjc	Thermal resistance junction to case	$^{\circ}\text{C}/\text{W}$	0,04	Direct current, double side cooled

Mounting force : 10 ÷ 15 kN
Weight : 250 gram

